	© Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both				under both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater				neous Materia	als and Mfg Information			
Supplier 1	Information													
Company name* Comp				ompany unique ID			Unique ID Authority				Response Date*			
On Semicon	ductor										2021-02-04			
Contact Nar	me		Title - Contact			]	Phone - Contact*				Email - Contact*			
Product-En	nv-Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
uthorized	Representative*		Title - Representative			]	Phone - Representative*				Email - Representative*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
]	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date	Version	Manufactu	Manufacturing Site		eight*	UOM	Unit Type
		FQU2N60CTU QFC 600V 4.7ohm		m IPAK		2021-02-04	СРА			38	3.557	mg	Each	
Aanufact	turing Proccess Informa	tion												
Т	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-		J-STD-020 MSI	L Rating	Peak Process Body Tempera		erature Max T	ture Max Time at Peak Tempo		e Numb	er of Reflow Cyc	cles
Matte Tin (Sn) - annealed		C	CU Alloy NA		NA		0 C		30	<b>30</b> se		3 3		
omments														
or more in	formation regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	HS RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	5.93	mg	Supplier	Silicon (Si)	7440-21-3		5.93	mg	
Die Attach	2.35	mg	Supplier	Silver (Ag)	7440-22-4		0.0352	mg	
			А	Lead (Pb)	7439-92-1	7a	2.1972	mg	
			Supplier	Tin (Sn)	7440-31-5		0.1175	mg	
Lead Frame	235.307	mg	В	Nickel (Ni)	7440-02-0		0.001	mg	
			Supplier	Iron (Fe)	7439-89-6		0.235	mg	
			Supplier	Copper (Cu)	7440-50-8		234.9999	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.071	mg	
Mold Compound-Black	129.0	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		25.8	mg	
			Supplier	Carbon Black (C)	1333-86-4		1.29	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		101.91	mg	
Plating	8.53	mg	Supplier	Tin (Sn)	7440-31-5		8.53	mg	
Wire Bond - Al	2.44	mg	Supplier	Aluminum (Al)	7429-90-5		2.44	mg	